### PATENT COOPERATION TREATY

#### From the

INTERNATIONAL SEARCHING AUTHORITY

To: LEE, Young-Pil		PCT			
The Cheonghwa Bldg. 1571-18 Seocho Seoul 137-874 Republic of Korea	The Cheonghwa Bldg. 1571-18 Seocho-dong, Seocho-gu Seoul 137-874 Republic of Korea		WRITTEN OPINION OF THE INTERNATIONAL SEARCHING AUTHORITY  (PCT Rule 43bis.1)		
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		Date of mailing (day/month/year) 2	9 MAY 2004 (29.05.2004)		
Applicant's or agent's file reference PH-21532-PCT		FOR FURTHER A	CTION See paragraph 2 below		
International application No.	International filing date	(day/month/year)	Priority date(day/month/year)		
PCT/KR2004/000374	24 FEBRUARY 20	004 (24.02.2004)	09 JUNE 2003 (09.06.2003)		
International Patent Classification (IPC) of IPC7 H01L 33/00	or both national classifica	tion and IPC			
Applicant POSTECH FOUNDATION et	al				
Box No. IV Lack of unity of X Box No. V Reasoned stater citations and exp Box No. VI Certain docume Box No. VII Certain defects Box No. VIII Certain observa	nion  nent of opinion with regard of invention  ment under Rule 43bis. I(a planations supporting suc ents cited s in the international appli	d to novelty, inventive  a)(i) with regard to nove  h statement	step and industrial applicability elty, inventive step or industrial applicability;		
International Preliminary Examining other than this one to be the IPEA and opinions of this International Searchin If this opinion is, as provided above, or	Authority ("IPEA") except the chosen IPEA has not not he sufficiently will not be sufficiently with the considered to be a written	ot that this does not app tified the International to considered.	nsidered to be a written opinion of the oly where the applicant chooses an Authority Bureau under Rule 66.1 bis(b) that written he applicant is invited to submit to the		
IPEA a written reply together, where of Form PCT/ISA/220 or before the e For further options, see Form PCT/IS	xpiration of 22 months fr		ation of 3 months from the date of mailing hichever expires later.		
3. For further details, see notes to Form	PCT/ISA/220.				

Name and mailing address of the ISA/KR



Korean Intellectual Property Office 920 Dunsan-dong, Seo-gu, Daejeon 302-701, Republic of Korea

Facsimile No. 82-42-472-7140

Authorized officer

KIM, Dong Yup

Telephone No. 82-42-481-5749



# WRITTEN OPINION OF THE INTERNATIONAL SEARCHING AUTHORITY

International application No.

PCT/KR2004/000374

ъ	BOX NO. 1 Basis of this opinion							
1.	<ol> <li>With regard to the language, which it was filed, unless oth</li> </ol>	-		on the basis o	f the intern	ational applic	cation in the la	anguage in
	This opinion has been Rules 12.3 and 23.1(b)	, which is the la						
2.	<ol><li>With regard to any nucleot claimed invention, this opinion</li></ol>		_		the interna	itional applic	ation and nec	essary to the
	a. type of material							
	a sequence listing table(s) related to the	e sequence listing						
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International application No.

PCT/KR2004/000374

### Box No. V Reasoned statement under Rule 43bis.1(a)(i) with regard to novelty, inventive step or industrial applicability; citations and explanations supporting such statement

Claims	1-15	YES
Claims	NONE	NO
Claims	7-8, 14-15	YES
Claims	1-6, 9-13	NO
Claims	1-15	YES
Claims	NONE	NO
	Claims Claims Claims Claims	Claims NONE  Claims 7-8, 14-15  Claims 1-6, 9-13  Claims 1-15

#### 2. Citations and explanations:

The documents cited in the International Search Report:

D1 : KR 2003-85272 A D2 : JP 2003-73859 A D4 : JP 2003-45661 A D5 : JP 2000-31462 A

D3 : WO 94/00885 A1

The subject-matter of Claims 1-6 and 9-13 lacks an inventive step under PCT Article 33(3).

The subject-matter of Claims 1-6 and 9-13 is a contacts fabric invention using heterostructures of metal/semiconductor nanorods and a manufacturing method thereof. Heterostructures are produced by the method comprising the following steps: depositing metal on the nano-material that is grown on a substrate orthogonally or unidirectionally; and the nano-material is selected from the group consisting of ZnO, GaN, Si and InP, and the metal is selected from the group consisting of Au, Cu, Pt, Al, Mn, Fe, Co, Ni and an alloy thereof.

D2 discloses a regularly arranged nano-structure joined on the substrate and a manufacturing method thereof. The substance forming the nano-structure can be a compound, which develops photocatalyst characteristics when absorbing at least ultraviolet radiation or the ultra-violet of sun light, such as TiO2 or ZnO. The regularly arranged nano-structure is obtained on the substrate, which has a morphology such as nanotube, nanodot, nano drill rod, nano fiber, and nano wire.

D3 discloses a light emitting device incorporating a layer of porous silicon of low dimensionality surmounted by a discontinuous layer of silver in the form of discrete islands. A digitated electrode is connected to the islands, and the islands have diameters in the range 5 nm to 20 nm and spacings in the range 10 nm to 50 nm. They form a Schottky diode structure on the silicon.

Therefore, the features of Claims 1-6 and 9-13 are already disclosed in D2 and D3 in a similar field of application, or are included among several straightforward possibilities or combinations from which the skilled person could select without the exercise of inventive skill.

Although D1 discloses all the features of Claims 1-6 and 9-13, D1 is published later than the priority date claimed in this application.

The subject matter of Claims 1-15 is considered to be industrially applicable.